

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2640715

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUN WANG	11/05/2013
RECEIVING PARTY DATA	
Name:	SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD.
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State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14124717
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Date:	12/08/2013
Total Attachments: 1 source=05_2_PUS1130812_CD13053_ASGN#page1.tif	

CH \$40.00 14124717

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1st Name: WANG, Jun
Residing at Shenzhen City, Guangdong, China

hereby sell(s), assign(s) and transfer(s) unto:

SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD. of
NO. 9-2, Tangming Road, Guangming district of Shenzhen, Guangdong 518132, China
(hereinafter referred as "ASSIGNEE"), its successors and assigns, the entire right, title and interest in and to the invention known as
METHOD FOR MANUFACTURING THIN-FILM TRANSISTOR ARRAY SUBSTRATE
hereinafter referred as "INVENTION"), for which a United States Patent Application was executed concurrently herewith or, if not so executed, was:

- a. executed on _____;
- b. filed on _____, Application Serial No. _____; or
- c. established by PCT International Patent Application No. PCT/CN2013/085364.

an application for Letters Patent of United States of America.

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

Signature of
1st Inventor Wang Jun Executed Date 2013.11.05